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--A method for the selective
electroplating of
a metallic substrate material band--

Abstract of the Disclosure

A method for the continuous selective electroplating of a metallic substrate material (10) and more particularly of a substrate material band having prestamped contact elements, comprises the following steps:

- a) the substrate material (10) is coated in an electrophoretic coating means (14) with an electrophoretic coating composition selective with at least one composition strip,
- b) the at least one composition strip is removed at those parts by means of a laser (40), which are to be electroplated,
- c) in an electroplating process a metal layer is applied to the areas (42) deprived of composition in at least one composition strip using selective electroplating and
- d) the at least one composition strip is then removed.

Figure 1